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H8/300L Super Low Power Series

Using Timer F to Implement Clock Operation

Introduction

A 32.768-kHz subclock (ϕ_w) is used for clock operation using timer F. Timer F interrupts are generated every 1 s to count up the counter for clock use in RAM.

When the counter is counted until 59 min. 59 s, the next count is initialized.

Target Device

H8/38024

Contents

1. Specifications	2
2. Description of Functions Used	2
3. Principle of Operation	10
4. Description of Software	12
5. RAM	16
6. Flowchart.....	17
7. Program Listing	19

1. Specifications

1. A 32.768-kHz subclock (ϕ_w) is used for clock operation using timer F.
2. Timer F interrupts are generated every 1 s, and a counter provided for clock use in RAM is incremented.
3. The clock counter provided in RAM has eight bits for counting seconds and eight bits for counting minutes. It starts counting from 00 min, 00 s, and after counting up to 59 min, 59 s, it is initialized to 00 min, 00 s in the next cycle and restarts counting.
4. After completion of initialization, a transition is made from active (high-speed) mode to watch mode. A timer F interrupt request causes a transition to subactive mode, the counter provided in RAM is incremented, and a transition is made again to watch mode.
5. The mode transition diagram for this sample task is shown in figure 1.

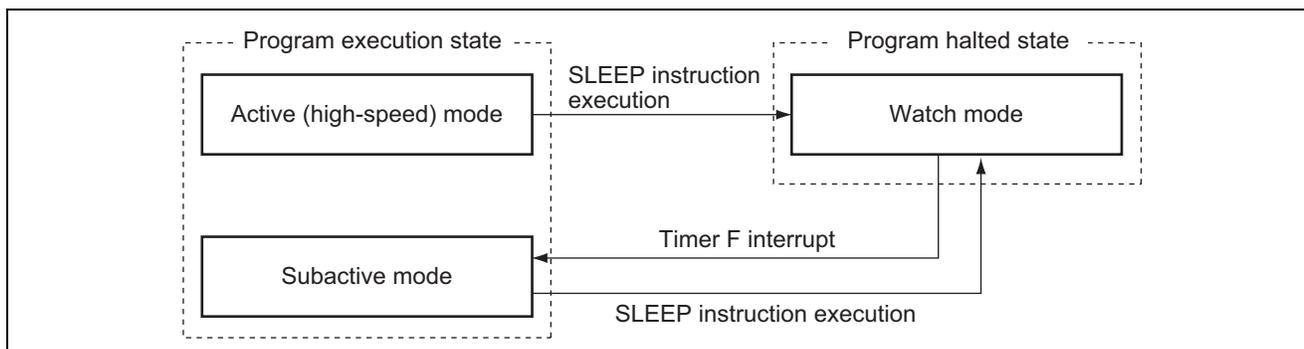


Figure 1 Diagram of Mode Transitions for this Sample Task

2. Description of Functions Used

1. In this sample task, clock operation is performed in which timer F is used to increment a counter provided in RAM every 1s. The features of timer F are as follows.
 - The system clock (ϕ) is a 5-MHz clock and a reference clock to operate the CPU and its peripheral functions.
 - The prescaler S (PSS) is a 13-bit counter using ϕ as its input clock and counted up every cycle.
 - ϕ_w is the output clock (32.768 kHz) of the subclock oscillator.
 - The prescaler W (PSW) is a 5-bit counter using a clock input obtained by dividing ϕ_w by 4 ($\phi_w/4$).
 - Four internal clocks ($\phi/32$, $\phi/16$, $\phi/4$, $\phi_w/4$) or an external clock can be selected (external event counting is possible).
 - A single compare-match signal can be used to output a toggle signal to the TMOFH pin (the initial value of the toggle output can be set).
 - The counter can be reset by a compare-match signal.
 - There are a total of two interrupt factors: one is compare-match, and the other is overflow.
 - Operation as two independent 8-bit timers (timer FH and timer FL) is also possible (in 8-bit mode).
 - When $\phi_w/4$ is selected as the internal clock, operation in watch mode, subactive mode, or sleep mode is possible.
 - Using the module standby mode, it is possible to set the module in standby mode independently when not in use.

2. Figure 2 shows a block diagram of the 16-bit output compare function of timer F used in this sample task.

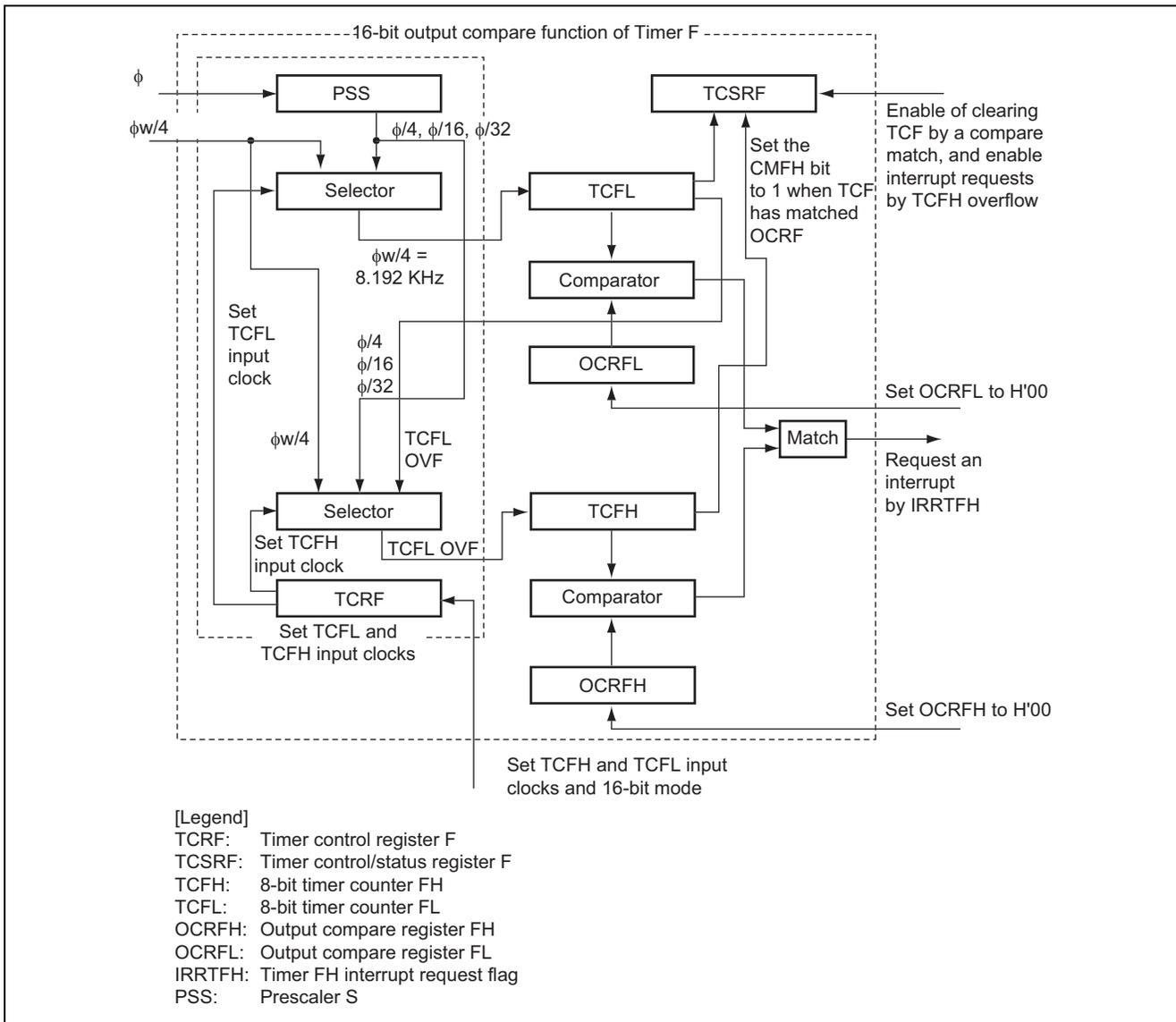


Figure 2 Block Diagram of 16-Bit Output Compare Function of Timer F

3. Table 1 shows timer F functions.

Table 1 Timer F Functions

Register	Functions
Timer control register F (TCRF)	TCRF is an 8-bit write-only register. It switches between 16-bit mode and 8-bit mode, selects the clock source from among four types of internal clocks and an external event, and sets the output levels of the TMOFH and TMOFL pins. On reset, TCRF is initialized to H'00.
Timer control status register F (TCSRf)	TCSRf is an 8-bit readable/writable register. It selects counter clear, sets the overflow flag, sets the compare match flag, and controls enabling interrupt requests due to overflows.
16-bit timer counter F (TCF)	TCF is a 16-bit readable/writable up-counter. It consists of cascade connections of the 8-bit timer counters (TCFH and TCFL). In addition to use as a 16-bit counter employing TCFH for the upper eight bits and TCFL for the lower eight bits, TCFH and TCFL can also be used as independent 8-bit counters. TCFH and TCFL can be read and written by the CPU, but when used in 16-bit mode, data transfer with the CPU is via a temporary register (TEMP). On reset, TCFH and TCFL are both initialized to H'00. When the CKSH2 bit in TCRF is cleared to 0, then TCF functions as a 16-bit counter. The TCF input clock can be selected using the CKSL2 to CKSL0 bits in TCRF. The CCLRf bit in TCSRf can be used to clear TCF on compare match. When TCF overflows, the OVfH bit in TCSRf is set to 1, and when the IENTfH bit in IENR2 is 1, an interrupt request is sent to the CPU.
8-bit timer counter FH (TCFH)	TCFH can be made to operate as an independent 8-bit counter by setting the CKSH2 bit in TCRF to 1. The TCFH input clock is selected using the CKSH2 to CKSH0 bits in TCRF. The CCLRf bit in TCSRf can be used to clear TCFH on a compare match. When there is an overflow of TCFH, the OVfH bit in TCSRf is set to 1. At this time, when the OVIEH bit in TCSRf is 1, the IRRfFH bit in IRR2 is set to 1, and when the IENTfH bit in IENR2 is 1, an interrupt request is sent to the CPU.
8-bit timer counter FL (TCFL)	TCFL can be made to operate as an independent 8-bit counter by setting the CKSH2 bit in TCRF to 1. The TCFL input clock is selected using the CKSL2 to CKSL0 bits in TCRF. The CCLRf bit in TCSRf can be used to clear TCFL on a compare match. When there is an overflow in TCFL, the OVfL bit in TCSRf is set to 1. At this time, if the OVIEL bit in TCSRf is 1, the IRRfFL bit in IRR2 is set to 1. When the IENTfL bit in IENR2 is 1, an interrupt request is sent to the CPU.

Register	Functions
16-bit output compare register F (OCRF)	<p>OCRF is a 16-bit readable/writable register which consists of two registers (OCRFH and OCRFL). In addition to being used as a 16-bit register of which OCRFH is the upper eight bits and OCRFL is the lower eight bits, OCRFH and OCRFL can also be used as independent 8-bit registers. OCRFH and OCRFL can be read and written by the CPU, but when used in 16-bit mode, data transfer with the CPU is via TEMP. On reset, OCRFH and OCRFL are both initialized to H'FF.</p> <p>On clearing the CKSH2 bit in TCRF to 0, OCRF functions as a 16-bit register. The contents of OCRF are constantly compared with TCF, and when the values of the two match, the CMFH bit in TCSR is set to 1. At the same time, the IRRTFH bit in IRR2 is also set to 1. At this time when the IENTFH bit in IENR2 is 1, an interrupt request is sent to the CPU. The toggle signal of a compare match can be output from the TMOFH pin. In addition, the TOLH bit in TCRF can be used to select the output level (high/low).</p>
8-bit output compare register FH (OCRFH)	<p>When the CKSH2 bit in TCRF is set to 1, OCRF functions as two 8-bit registers. The contents of OCRFH are compared with TCFH, and the contents of OCRFL are compared with TCFL. When the values of OCRFH and TCFH match, the CMFH bit in TCSR is set to 1. At the same time, the IRRTFH bit in IRR2 is also set to 1. At this time when the IENTFH bit in IENR2 is 1, an interrupt request is sent to the CPU. The toggle signal of a compare match can be output from the TMOFH pin. In addition, the TOLH bit of TCRF can be used to select the output level (high/low).</p>
8-bit output compare register FL (OCRFL)	<p>When the CKSH2 bit in TCRF is set to 1, OCRF functions as two 8-bit registers. The contents of OCRFH are compared with TCFH, and the contents of OCRFL are compared with TCFL. When the values of OCRFL and TCFL match, the CMFL bit in TCSR is set to 1. At the same time, the IRRTFL bit in IRR2 is also set to 1. At this time when the IENTFL bit in IENR2 is 1, an interrupt request is sent to the CPU. The toggle signal of a compare match can be output from the TMOFL pin. In addition, the TOLL bit of TCRF can be used to select the output level (high/low).</p>
Timer FH interrupt request flag (IRRTFH)	<p>IRRTFH is set to 1, when TCF matches OCRF in 16-bit mode, when TCFH matches OCRFH in 8-bit mode, or when TCF and TCFH overflow in the state that IENTFH is set to 1. IRRTFH is cleared to 0, when IRRTFH is written to 1 in the state that IRRTFH is set to 1.</p>
Timer FL interrupt request flag (IRRTFL)	<p>IRRTFL is set to 1, when TCFL matches OCRFL in 8-bit mode or when TCFL overflows in the state that IENTFL is set to 1. IRRTFL is cleared to 0, when IRRTFL is written to 1 in the state that IRRTFL is set to 1.</p>
Timer FH interrupt enable (IENTFH)	<p>IENTFH enables or disables interrupt requests caused by timer FH compare match or overflow.</p>
Timer FL interrupt enable (IENTFL)	<p>IENTFL enables or disables interrupt requests caused by timer FL compare match or overflow.</p>
Timer F event input (TMIF)	<p>TIMF is used as an event input pin to TCFL.</p>
Timer FH output (TMOFH)	<p>TMOFH is a timer FH toggle output pin.</p>
Timer FL output (TMOFL)	<p>TMOFL is a timer FL toggle output pin.</p>

4. The method for setting the timer FH interrupt cycle is described below.

In this sample task, 32.768 kHz is used for ϕ_w , and the timer F functions as a clock time base.

By setting CKSL2 to 1, CKSL1 to 1 and CKSL0 to 1 in TCRF, the TCF input clock is set to $\phi_w/4$. Here $\phi_w/4$ is given by the equation below

$$\phi_w/4 = 32.768 \text{ kHz}/4 = 8.192 \text{ kHz}$$

Hence the TCF input clock cycle is

$$1/8.192 \text{ kHz} \cong 122.07 \mu\text{s}$$

Here when OCRF is set to H'2000, then the time until the values of TCF and OCRF match is calculated as

$$H'2000 \times (1/8.192 \text{ kHz}) = 8192 \times 122.07 \mu\text{s} = 1 \text{ s}$$

Hence the settings for OCRF used to set the timer FH interrupt cycle T_{FH} are calculated by the following equation.

$$\text{OCRF setting} = T_{FH} / (1/8.192 \text{ kHz}) = T_{FH} \times 8.192 \text{ kHz}$$

Table 2 shows timer FH interrupt cycle T_{FH} values and OCRF setting examples.

Table 2 Examples of Timer FH Interrupt Cycles and OCRF Settings

T_{FH} (s)	Calculation	OCRF Setting
0.125	$0.125 \text{ s} \times 8.192 \text{ kHz} = 1024$	H'0400
0.250	$0.250 \text{ s} \times 8.192 \text{ kHz} = 2048$	H'0800
0.500	$0.500 \text{ s} \times 8.192 \text{ kHz} = 4096$	H'1000
1.000	$1.000 \text{ s} \times 8.192 \text{ kHz} = 8192$	H'2000
2.000	$2.000 \text{ s} \times 8.192 \text{ kHz} = 16384$	H'4000

5. The interface with the CPU is described below.

TCF and OCRF are 16-bit readable/writable registers. On the other hand, the data bus between the CPU and internal peripheral modules has an 8-bit data width. Hence when the CPU accesses TCF or OCRF, it must do so via the 8-bit temporary register (TEMP).

When reading or writing TCF or writing OCRF in 16-bit mode, operations must always be performed in 16-bit units (with two consecutive byte-size MOV instructions), in the order of the upper byte firstly and lower byte secondly.

When only the upper byte or only the lower byte is accessed, the data is not transferred correctly.

In 8-bit mode, there are no restrictions on access order.

a. Write operation

By writing the upper byte, the upper byte data is transferred to TEMP. Next the lower byte is written; the data in TEMP is written to the upper byte register, and the lower-byte data is written directly to the lower byte register.

The TCF write operation when H'AA55 is written to TCF is shown in Figure 3.

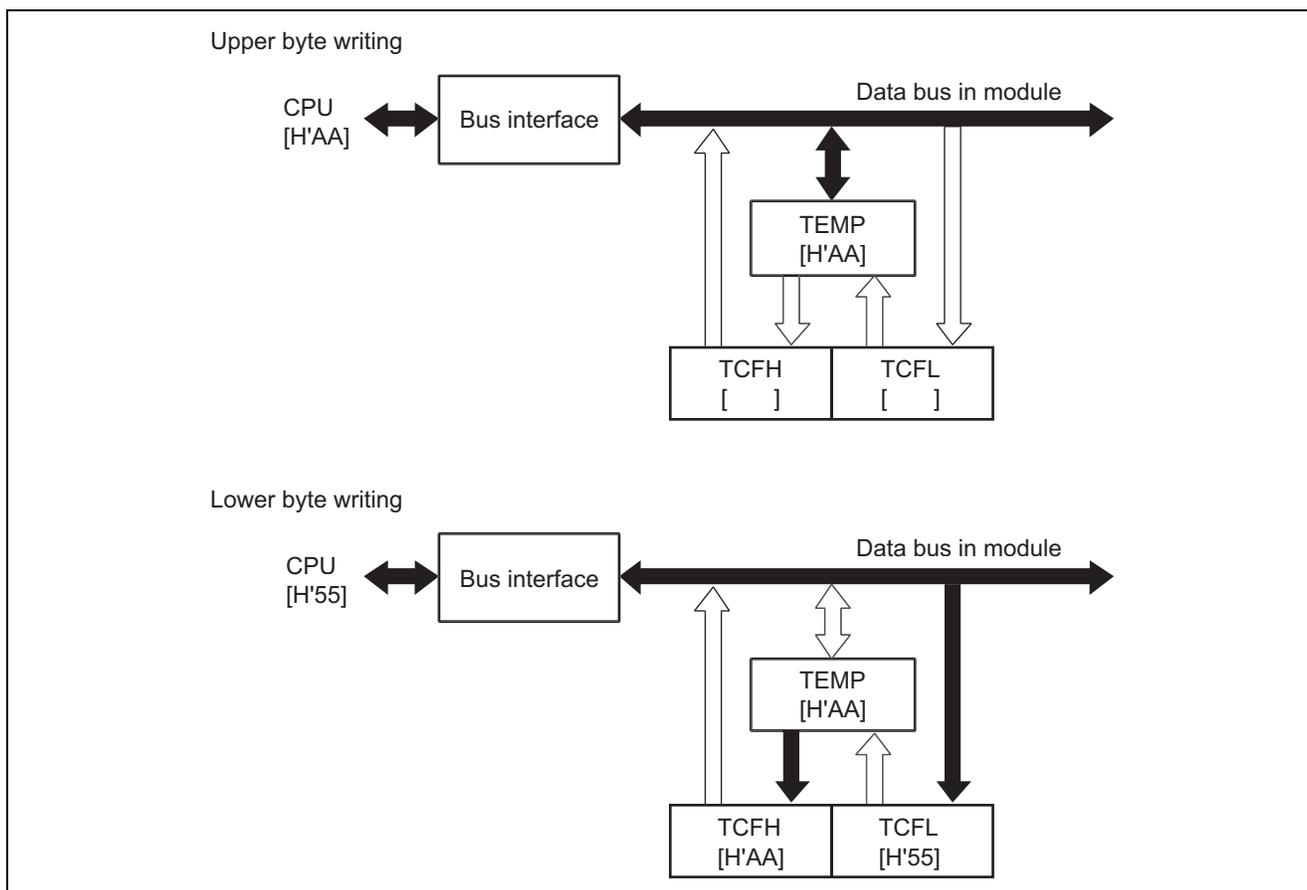


Figure 3 TCF Write Operation

b. Read operation

In the case of TCF, when the upper byte is read, the upper byte data is transferred directly to the CPU, and the lower byte data is transferred to TEMP. Next the lower byte data is read; the lower byte data in TEMP is transferred to the CPU.

In the case of OCFR, in upper byte reading the upper byte data is transferred directly to the CPU. In lower byte reading the lower byte data is also transferred directly to the CPU.

Figure 4 shows a TCF read operation when TCF contains H'AAFF

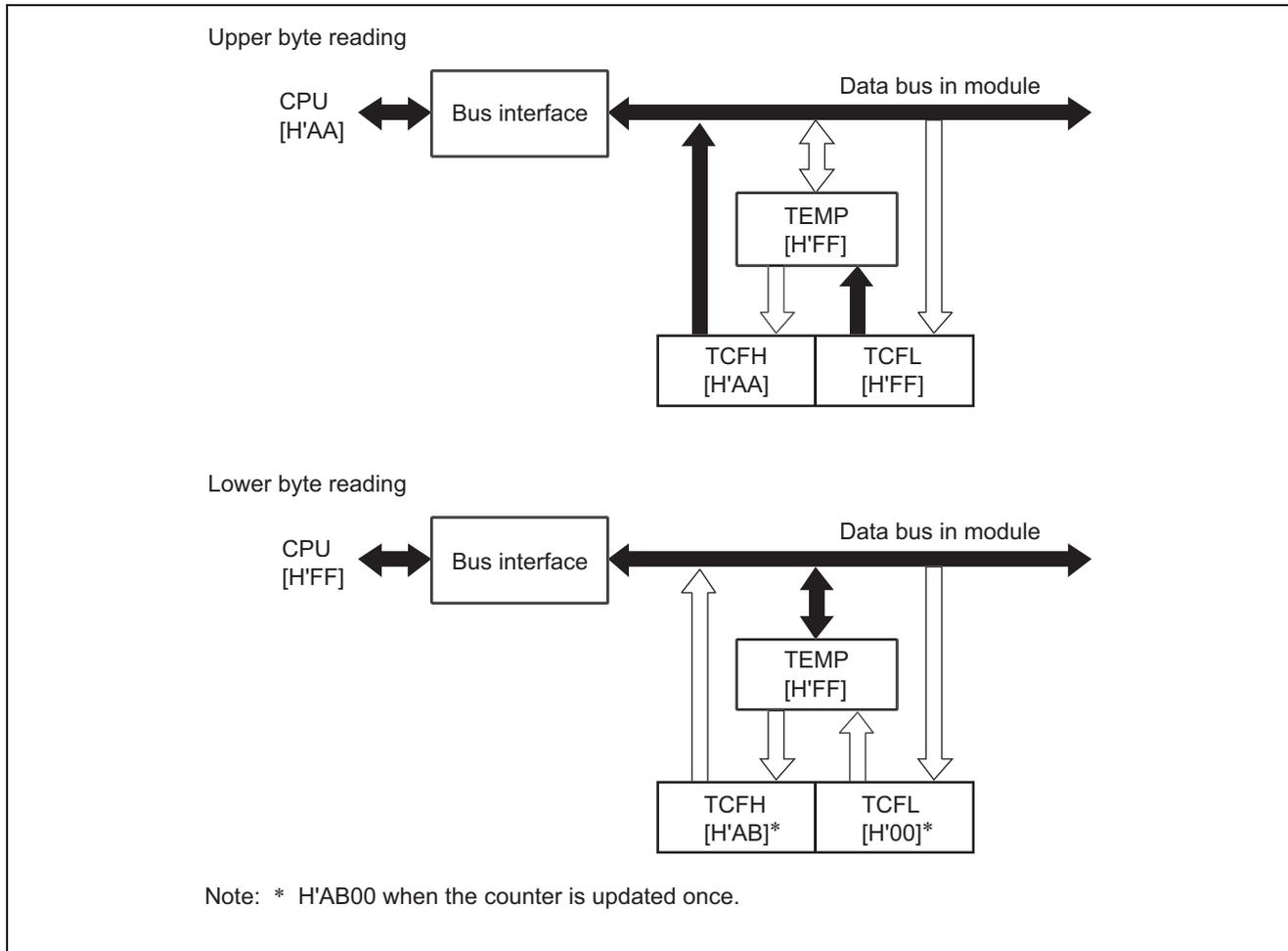


Figure 4 TCF Read Operation

6. Notes on use of the timer F

While the timer F is operating in 16-bit timer mode, the following conflicts and operations may occur.

- a. When all 16 bits match and a compare match signal is generated, the toggle signal is output from the TMOFH pin. When TCRF writing by a MOV instruction and a compare match signal occur simultaneously, TOLH data resulting from TCRF writing is output to TMOFH pin. In 16-bit mode, the TMOFL pin output is unstable, and should not be used. Use it as a port instead.
- b. When OCRFL writing and compare match signal generation occur simultaneously, the compare match signal is invalid. However, when the written data compare matches the counter value, at that point a compare match signal is generated. The compare match signal is output in synchronization with the TCFL clock, so that when the clock is stopped, no compare match signal is generated even when a compare match occurs.
- c. When all 16 bits match and a compare match signal is generated, the compare match flag CMFH is set. Similarly, when setting conditions for the lower 8 bits are satisfied, CMFL is set.
- d. When there is a TCF overflow, OVFH is set; when the lower 8 bits of OVFL overflow, when setting conditions are satisfied, OVFL is set. When TCFL writing and overflow signal output occur simultaneously, the overflow signal is not output.
- e. In active mode and sleep mode, when $\phi_w/4$ is selected as the TCF internal clock, synchronization is established by the synchronization circuit since the system clock and internal clock are mutually asynchronous, and so synchronization is established by asynchronization. This results in a maximum count cycle error of $1/\phi$ (sec). In order to prevent this error from occurring, the system must be operated in subactive mode, subsleep mode, or watch mode.

7. Table 3 shows the assignment of functions in this sample task.

Table 3 Function Assignment

Function	Assignment
TCRF	Sets 16-bit mode and selects TCFL input clock.
TCSRf	Selects counter clear, sets the overflow flag, sets the compare match flag, and enables/disables interrupt requests due to overflows.
TCF	Functions as a 16-bit up-counter configured by TCFH and TCFL. TCF counts with internal clock ($\phi_w/4$), and sets the IRTFH and CMFH bits to 1 when a compare match occurs.
OCRf	16-bit register configured by OCRFH and OCRFL. When the value set in OCRf matches the one in TCF, a compare match signal is generated.
SYSCR1	Controls power down modes.
SYSCR2	Controls power down modes.
IRRTFH	Indicates whether or not a timer FH interrupt is requested.
IENRFH	Enables or disables timer FH interrupt requests.
ϕ_w	Subclock frequency; this is set to 32.768 kHz in this sample task.
TMA3	Sets transition to watch mode.

3. Principle of Operation

1. Operation of the timer F in 16-bit timer mode is described below.

Timer F is a 16-bit counter which is incremented each time a clock pulse is input. The value of the timer counter F is constantly compared with the value set in the output compare register F; when they match, the operations that the counter is cleared, an interrupt request is issued, and port toggle is output are possible. It can also function as two independent 8-bit timers.

When CKSH2 bit in timer control register F (TCRF)

Immediately after a reset, the timer counter F (TCF) is initialized to H'0000, the output compare register F (OCRF) to H'FFFF, and the timer control register F (TCRF) and timer control status register F (TCSRf) are both initialized to H'00. The counter starts incrementing by input from an external event (TMIF). The external event edge selection is set by the IEG3 bit in the IRQ edge select register (IEGR).

Using the CKSL2 through CKSL0 bits in TCRF, the operating clock for timer F is selected from three kinds of internal clocks output by PSS, an internal clock of $\phi_w/4$, or an external clock.

The contents of TCF and OCRF are constantly compared; when the both values match, the CMFH bit in TCSRf is set to 1. At this time when the IENTFH bit in IENR2 is 1 an interrupt request is sent to the CPU, and at the same time the toggle signal is output from the TMOFH pin. Also, when the CCLRH bit in TCSRf is 1, TCF is cleared. The output from pin TMOFH can be set by the TOLH bit in TCRF.

When TCF overflows (H'FFFF \rightarrow H'0000), the OVFH bit in TCSRf is set to 1. At the time, when both the OVIEH bit in TCSRf and the IENTFH bit in IENR2 are 1, an interrupt request is sent to the CPU.

2. Timer F operating modes are shown in Table 4.

Table 4 Timer F Operating Modes

Operating Mode	Reset	Active	Sleep	Watch	Sub-active	Sub-sleep	Standby	Module standby
TCF	Reset	Functions	Functions	Functions/ Halted	Functions/ Halted*	Functions/ Halted*	Halted	Halted
OCRf	Reset	Functions	Held	Held	Functions	Held	Held	Held
TCRF	Reset	Functions	Held	Held	Functions	Held	Held	Held
TCSRf	Reset	Functions	Held	Held	Functions	Held	Held	Held

Note: * When $\phi_w/4$ is selected as the TCF's internal clock in active mode or sleep mode, the system clock and internal clock are mutually asynchronous, and so synchronization is established by a synchronization circuit. This results in a maximum error of $1/\phi(s)$ in the count period.

When the counter is operated in subactive mode, watch mode, or subsleep mode, $\phi_w/4$ must always be selected as the internal clock. The counter will not operate when any other internal clock is selected.

3. Figure 5 shows the operating theory in this sample task.

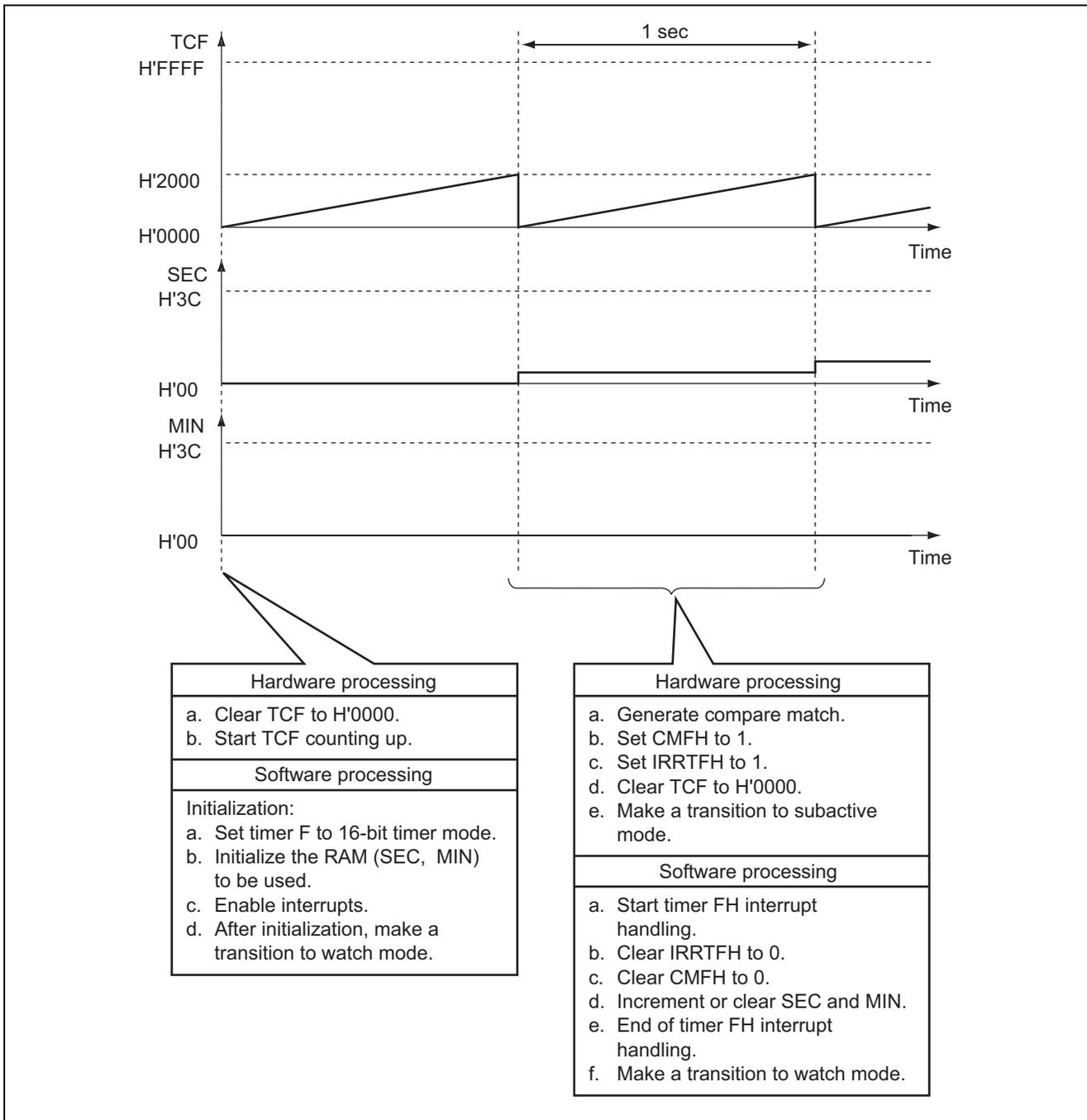


Figure 5 Timer F Operating Theory

4. Description of Software

4.1 Modules

The modules used in this sample task are shown in table 5.

Table 5 Description of Modules

Module	Label	Function
Main routine	main	Initializes RAM and timer F, enables interrupts, and makes a transition to watch mode.
Timer F interrupt handling routine	tfint	Clears IRRTFH and CMFH to 0, save register data, increments or clears SEC and MIN defined in RAM, and restores register data.

4.2 Arguments

Table 6 describes the arguments used in this sample task.

Table 6 Description of Arguments

Arguments	Function	Module Used	Data Length	Input/Output
SEC	A clock counter for counting seconds	main, tfint	1 byte	Output
MIN	A clock counter for counting minutes	main, tfint	1 byte	Output

4.3 Internal Registers

Table 7 shows the internal registers used in this sample task.

Table 7 Description of Internal Registers

Register	Function	Address	Setting		
TCRF	CKSH2	Timer Control Register F (Clock Select H2 to 0)	H'FFB6	CKSH2 = 0	
	CKSH1	Select the clock input to TCFH from among four internal clock sources or a TCFL overflow. When CKSH2 = 0, CKSH1 = 0 and CKSH0 = 0, TCFL overflow is selected When CKSH2 = 0, CKSH1 = 0 and CKSH0 = 1, TCFL overflow is selected When CKSH2 = 0, CKSH1 = 1 and CKSH0 = 0, TCFL overflow is selected When CKSH2 = 0, CKSH1 = 1 and CKSH0 = 1, this setting is prohibited When CKSH2 = 1, CKSH1 = 0 and CKSH0 = 0, internal clock $\phi/32$ is selected When CKSH2 = 1, CKSH1 = 0 and CKSH0 = 1, internal clock $\phi/16$ is selected When CKSH2 = 1, CKSH1 = 1 and CKSH0 = 0, internal clock $\phi/4$ is selected When CKSH2 = 1, CKSH1 = 1 and CKSH0 = 1, internal clock $\phi_w/4$ is selected	Bit 6	CKSH1 = 0	
	CKSH0		Bit 5	CKSH0 = 0	
			Bit 4		
	CKSL2		Timer Control Register F (Clock Select L2 to 0)	H'FFB6	CKSL2 = 1
	CKSL1		Select the clock input to TCFL from among four internal clock sources or an external event. When CKSL2 = 0, CKSL1 = 0 and CKSL0 = 0, an external event is selected When CKSL2 = 0, CKSL1 = 0 and CKSL0 = 1, an external event is selected When CKSL2 = 0, CKSL1 = 1 and CKSL0 = 0, an external event is selected When CKSL2 = 0, CKSL1 = 1 and CKSL0 = 1, this setting is prohibited When CKSL2 = 1, CKSL1 = 0 and CKSL0 = 0, internal clock $\phi/32$ is selected When CKSL2 = 1, CKSL1 = 0 and CKSL0 = 1, internal clock $\phi/16$ is selected When CKSL2 = 1, CKSL1 = 1 and CKSL0 = 0, internal clock $\phi/4$ is selected When CKSL2 = 1, CKSL1 = 1 and CKSL0 = 1, internal clock $\phi_w/4$ is selected	Bit 2	CKSL1 = 1
	CKSL0			Bit 1	CKSL0 = 1
				Bit 0	

Register		Function	Address	Setting
TCSR	OVFH	Timer Control/Status Register F (Timer Overflow Flag H) A status flag indicating whether or not TCF has overflowed. When OVFH = 0, indicates no overflow of TCF When OVFH = 1, indicates TCF overflow	H'FFB7 Bit 7	0
	CMFH	Timer Control/Status Register F (Compare Match Flag H) A status flag indicating whether or not TCF has compare matched OCF. When CMFH = 0, indicates no compare match between TCF and OCF When CMFH = 1, indicates TCF has compare matched OCF	H'FFB7 Bit 6	0
	OVIEH	Timer Control/Status Register F (Timer Overflow Interrupt Enable H) Enables or disables interrupt requests when TCF overflows. When OVIEH = 0, disables TCF overflow interrupt requests. When OVIEH = 1, enables TCF overflow interrupt requests.	H'FFB7 Bit 5	1
	CCLR	Timer Control/Status Register F (Counter Clear H) Selects whether or not TCF is cleared when TCF has compare matched OCF. When CCLR = 0, disables TCF clear by compare match When CCLR = 1, enables TCF clear by compare match	H'FFB7 Bit 4	1
TCFH	Timer Counter FH Upper 8 bits of 16-bit timer counter F (TCF); functions as an 8-bit up-counter using a TCFL overflow signal as an input clock.	H'FFB8	H'00	
TCFL	Timer Counter FL Lower 8 bits of 16-bit timer counter F (TCF); functions as an 8-bit up-counter using $\phi_w/4$ of internal clock as an input clock.	H'FFB9	H'00	
OCRFH	Output Compare Register FH Upper 8 bits of 16-bit output compare register (OCRF); generates a compare match signal when OCF has matched TCF.	H'FFBA	H'20	
OCRFL	Output Compare Register FL Lower 8 bits of 16-bit output compare register (OCRF); generates a compare match signal when OCF has matched TCF.	H'FFBB	H'00	
IENR2	IENTFH	Interrupt Enable Register 2 (Timer FH Interrupt Enable) Enables or disables timer FH interrupt requests. When IENTFH = 0, disables timer FH interrupt requests When IENTFH = 1, enables timer FH interrupt requests	H'FFF4 Bit 3	1
IRR2	IRRTFH	Interrupt Request Register 2 (Timer FH Interrupt Request Flag) Indicates whether or not there has been a timer FH interrupt request. When IRRTFH = 0, indicates that no timer FH interrupt has been requested When IRRTFH = 1, indicates that a timer FH interrupt has been requested	H'FFF7 Bit 3	0

Register	Function	Address	Setting
SYSCR1	SSBY	System Control Register 1 (Software Standby) Carries out transitions to standby mode or watch mode. When SSBY = 0, after executing a SLEEP instruction in active mode, a transition is made to sleep mode, or after executing a SLEEP instruction in subactive mode, a transition is made to subsleep mode. When SSBY = 1, after executing a SLEEP instruction in active mode, a transition is made to standby mode or to watch mode, or after executing a SLEEP instruction in subactive mode, a transition is made to watch mode.	H'FFF0 1 Bit 7
STS2	System control register 1 (Standby Timer Select 2 to 0)	H'FFF0	STS2 = 0
STS1	Specify the time for the CPU and peripheral functions to wait until the clock stabilizes when standby mode or watch mode is cleared and a transition is made to active mode due to a specific interrupt. Note that the standby time must be specified to be equal to or longer than the oscillation stabilization time according to the operating frequency. When STS2 to STS1 = 000, standby time is 8,192 states When STS2 to STS1 = 001, standby time is 16,384 states When STS2 to STS1 = 010, standby time is 1,024 states When STS2 to STS1 = 011, standby time is 2,048 states When STS2 to STS1 = 100, standby time is 4,096 states When STS2 to STS1 = 101, standby time is 2 states When STS2 to STS1 = 110, standby time is 8 states When STS2 to STS1 = 111, standby time is 16 states	Bit 6	STS1 = 0
STS0		Bit 5 Bit 4	STS0 = 0
LSON	System Control Register 1 (Low Speed On Flag) When watch mode is cleared, selects either the system clock or the subclock as the CPU operating clock. When LSON = 0, selects the system clock as the CPU operating clock When LSON = 1, selects the subclock as the CPU operating clock	H'FFF0 Bit 3	1
SYSCR2	DTON	System Control Register 2 (Direct Transfer On Flag) Specifies whether or not to make direct transitions among active (high-speed) mode, active (medium-speed) mode, and subactive mode when a SLEEP instruction is executed. When DTON = 0 and a SLEEP instruction is executed in active mode, a transition to standby mode, watch mode or sleep mode occurs When DTON = 1 and a SLEEP instruction is executed in active (high-speed) mode, a direct transition occurs to active (medium-speed) mode (when SSBY = 0, MSON = 1, LSON = 0) or to subactive mode (when SSBY = 1, TMA3 = 1, LSON = 1)	H'FFF1 0 Bit 3
MSON	System Control Register 2 (Medium Speed On Flag) Selects whether to operate in active (high-speed) mode or in active (medium-speed) mode after clearing standby mode, watch mode, or sleep mode. When MSON = 0, operates in active (high-speed) mode When MSON = 1, operates in active (medium-speed) mode	H'FFF1 Bit 2	0

Register	Function	Address	Setting
TMA	TMA3	H'FFB0	1
	Timer Mode Register A (Timer Mode Register A3)	Bit 3	
	Selects the clock source input to TCA.		
	When TMA3 = 0, a change to standby mode can be made.		
	When TMA3 = 1, a change to active (high-speed) mode, active (medium-speed) mode, subactive mode, watch mode, or subsleep mode can be made.		

5. RAM

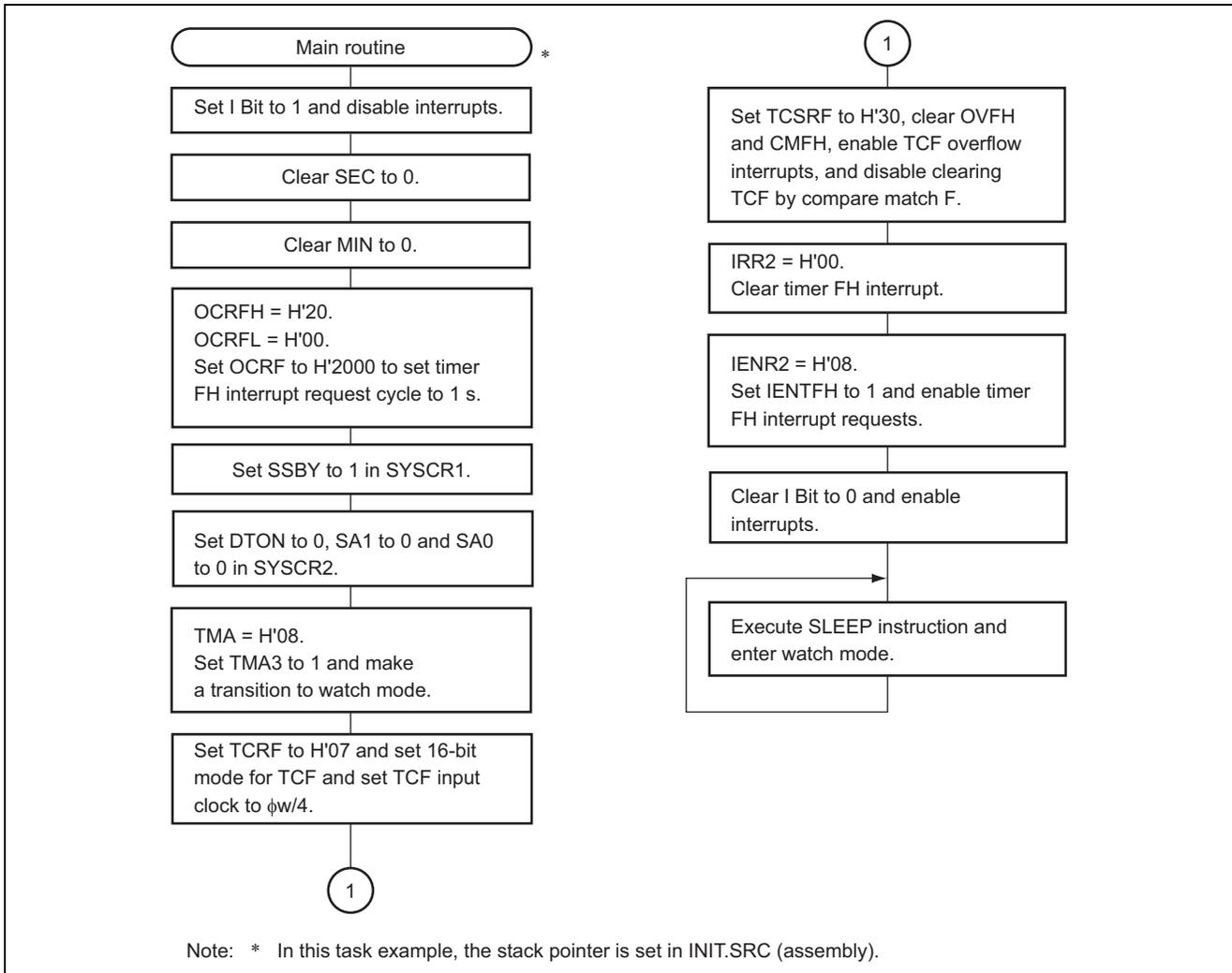
Table 8 describes the RAMs used in this sample task.

Table 8 Description of RAM Used

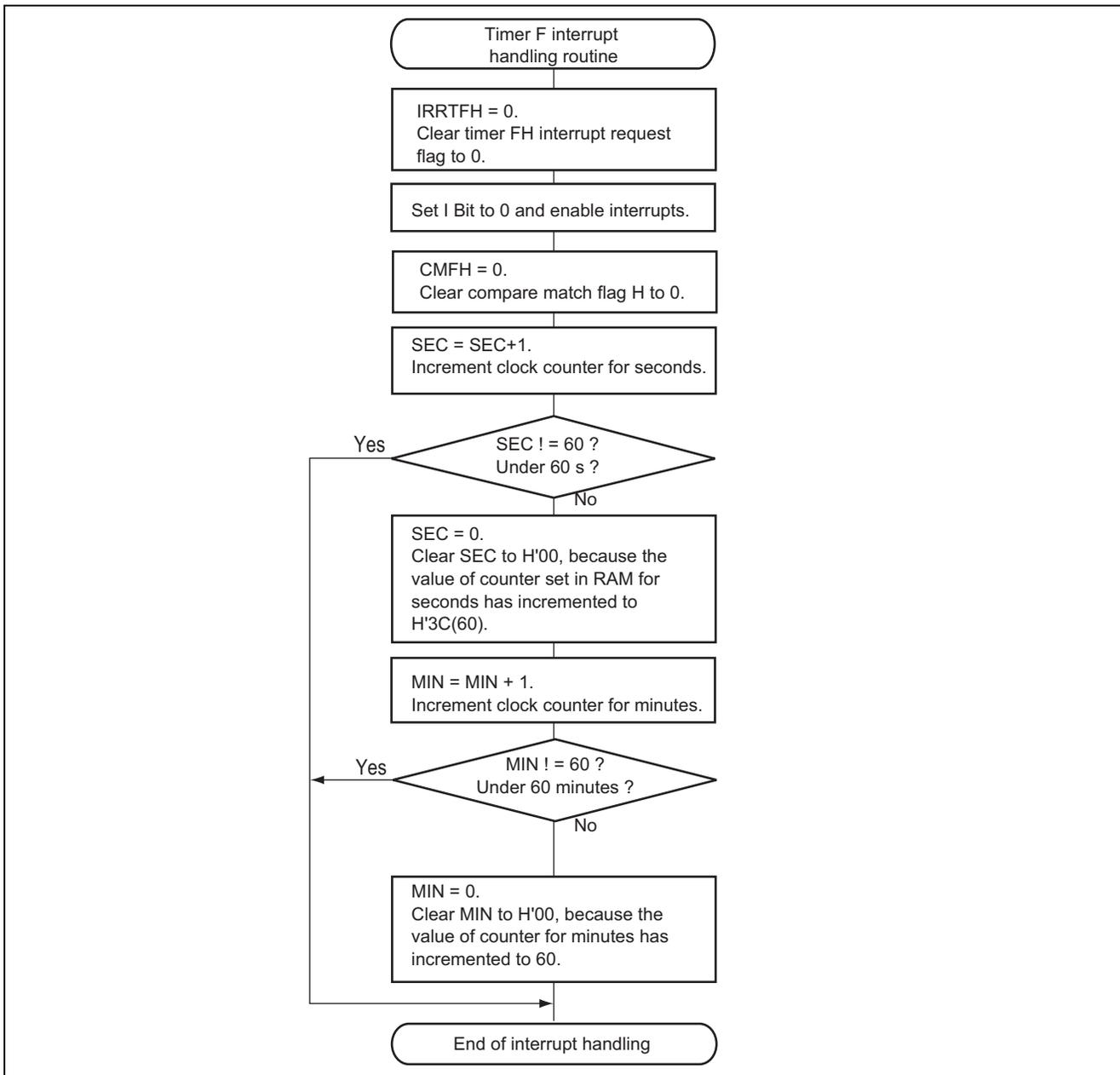
Label	Function	Address	Used in
SEC	Counter used for a clock, counting the seconds	H'FB80	Main routine Timer F interrupt handling routine
MIN	Counter used for a clock, counting the minutes	H'FB81	Main routine Timer F interrupt handling routine

6. Flowchart

1. Main routine



2. Timer F interrupt handling routine



7. Program Listing

INIT.SRC (Program listing)

```

        .EXPORT    _INIT
        .IMPORT    _main
;
        .SECTION   P, CODE
_INIT:
        MOV.W      #H'FF80, R7
        LDC.B      #B'10000000, CCR
        JMP        @_main
;
        .END

/*****
/*
/* H8/300L Super Low Power Series
/*   -H8/38024 Series-
/* Application Note
/*
/* 'Timer F -Clock Time Base-'
/*
/* Function
/* : Timer F
/*
/* External Clock : 10MHz
/* Internal Clock : 5MHz
/* Sub Clock : 32.768kHz
/*
*****/

#include    <machine.h>

/*****
/* Symbol Definition
*****/
struct BIT {
    unsigned char    b7:1;    /* bit7 */
    unsigned char    b6:1;    /* bit6 */
    unsigned char    b5:1;    /* bit5 */
    unsigned char    b4:1;    /* bit4 */
    unsigned char    b3:1;    /* bit3 */
    unsigned char    b2:1;    /* bit2 */
    unsigned char    b1:1;    /* bit1 */
    unsigned char    b0:1;    /* bit0 */
};

```

```

#define TMA          *(volatile unsigned char *)0xFFB0 /* Timer Mode Register A */
#define TCA          *(volatile unsigned char *)0xFFB1 /* Timer Counter A */
#define TCRF        *(volatile unsigned char *)0xFFB6 /* Timer Control Register F */
#define TCRF_BIT    (*(struct BIT *)0xFFB6) /* Timer Control Register F */
#define TOLH        TCRF_BIT.b7 /* Toggle Output Level F */
#define CKSH2       TCRF_BIT.b6 /* Clock Select H2 */
#define CKSH1       TCRF_BIT.b5 /* Clock Select H1 */
#define CKSH0       TCRF_BIT.b4 /* Clock Select H0 */
#define TCSRF       *(volatile unsigned char *)0xFFB7 /* Timer Control Status Register F */
#define TCSRF_BIT   (*(struct BIT *)0xFFB7) /* Timer Control Status Register F */
#define OVFH        TCSRF_BIT.b7 /* Timer Overflow Flag H */
#define CMFH        TCSRF_BIT.b6 /* Compare Match Flag H */
#define OVIEH       TCSRF_BIT.b5 /* Timer Overflow Interrupt Enable */
#define CCLRH       TCSRF_BIT.b4 /* Output Select 3 */
#define OCRFH       *(volatile unsigned char *)0xFFBA /* Output Compare Register FH */
#define OCRFL       *(volatile unsigned char *)0xFFBB /* Output Compare Register FH */
#define TMG         *(volatile unsigned char *)0xFFBC /* Output Compare Register FH */
#define SYSCR1      *(volatile unsigned char *)0xFFF0 /* System Control Register 1 */
#define SYSCR1_BIT  (*(struct BIT *)0xFFF0) /* System Control Register 1 */
#define SSBY        SYSCR1_BIT.b7 /* Software Standby */
#define STS2        SYSCR1_BIT.b6 /* Standby Timer Select 2 */
#define STS1        SYSCR1_BIT.b5 /* Standby Timer Select 1 */
#define STS0        SYSCR1_BIT.b4 /* Standby Timer Select 0 */
#define LSON        SYSCR1_BIT.b3 /* Low Speed On Flag */
#define MA1         SYSCR1_BIT.b1 /* Active Mode Clock Select 1 */
#define MA0         SYSCR1_BIT.b0 /* Active Mode Clock Select 0 */
#define SYSCR2      *(volatile unsigned char *)0xFFF1 /* System Control Register 2 */
#define SYSCR2_BIT  (*(struct BIT *)0xFFF1) /* System Control Register 2 */
#define NESEL       SYSCR2_BIT.b4 /* Noise Elimination Sampling
/* Frequency Select */
#define DTON        SYSCR2_BIT.b3 /* Direct Transfer On Flag */
#define MSON        SYSCR2_BIT.b2 /* Middle Speed On Flag */
#define SA1         SYSCR2_BIT.b1 /* Subactive Mode Clock Select 1 */
#define SA0         SYSCR2_BIT.b0 /* Subactive Mode Clock Select 0 */
#define IENR1_BIT   (*(struct BIT *)0xFFF3) /* Interrupt Enable Register 1 */
#define IENTA       IENR1_BIT.b7 /* Timer A Interrupt Enable */
#define IENR2       *(volatile unsigned char *)0xFFF4 /* Interrupt Enable Register 2 */
#define IENR2_BIT   (*(struct BIT *)0xFFF4) /* Interrupt Enable Register 2 */
#define IENDT       IENR2_BIT.b7 /* Direct Transfer Interrupt Enable */
#define IENTFH      IENR2_BIT.b3 /* Timer FH Interrupt Enable */
#define IENTG       IENR2_BIT.b4 /* Timer FH Interrupt Enable */
#define IRR1_BIT    (*(struct BIT *)0xFFF6) /* Interrupt Request Register 1 */
#define IRRTA       IRR1_BIT.b7 /* Timer A Interrupt Request Flag */
#define IRR2        *(volatile unsigned char *)0xFFF7 /* Interrupt Request Register 2 */
#define IRR2_BIT    (*(struct BIT *)0xFFF7) /* Interrupt Request Register 2 */
#define IRRDT       IRR2_BIT.b7 /* Direct Transfer Interrupt
/* Request Flag */
#define IRRTFH      IRR2_BIT.b3 /* Timer FH Interrupt Request Flag */
#define IRRTG       IRR2_BIT.b4 /* Timer FH Interrupt Request Flag */
#define CKSTPR1     *(volatile unsigned char *)0xFFFA /*
#define CKSTPR2     *(volatile unsigned char *)0xFFFB /*

#pragma interrupt      (tfint)

```

```

/*****
/* Function define
/*****
extern void INIT ( void );          /* SP Set
void main ( void );
void tfint ( void );

/*****
/* RAM define
/*****
unsigned char SEC;
unsigned char MIN;

/*****
/* Vector Address
/*****
#pragma section V1                /* Vector Section Set
void (*const VEC_TBL1[])(void) = {
    INIT                          /* 0x0000 Reset Vector
};
#pragma section V2                /* Vector Section Set
void (*const VEC_TBL2[])(void) = {
    tfint                         /* 0x001E Timer F Interrupt Vector
};

#pragma section                   /* P
/*****
/* Main Program
/*****
void main ( void )
{
    set_imask_ccr(1);             /* Interrupt Disable
    SEC = 0;
    MIN = 0;
    OCRFH = 0x20;                /* Initialize Compare Match FH Value
    OCRFL = 0x00;                /* Initialize Compare Match FL Value
    SYSCR1 = 0x8F;               /* Set SYSCR1
    SYSCR2 = 0xE0;               /* Set SYSCR2
    TMA = 0x08;                  /* Initialize TCA Overflow Period
    TCRF = 0x07;                 /* TMOFH High level Output
    TCSRf = 0x30;                /* Initialize Overflow Interrupt
    IRR2 = 0x00;
    IENR2 = 0x08;                /* Timer A Interrupt Enable
    set_imask_ccr(0);           /* Interrupt Enable
    while(1){
        sleep();                 /* Transition to Sleep Mode
    }
}

```

```

/*****
/* Timer F Interrupt
/*****
void tfint ( void )
{
    IRRTFH = 0;          /* Clear Timer F Interrupt Request */
    set_imask_ccr(0);   /* Interrupt Enable */

    CMFH = 0;          /* Clear Compare Match Flag H */
    SEC++;             /* Increment Second Counter */

    if ( SEC == 60 ){
        SEC = 0;       /* Initialize Second Counter */
        MIN++;        /* Increment Minute Counter */
        if ( MIN == 60 ){
            MIN = 0;   /* Initialize Minute Counter */
        }
    }
}

```

Link address specifications

Section Name	Address
CV1	H'0000
CV2	H'001E
P	H'0100
B	H'FB80

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